



1FW AF  
RESPONSE UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE

IN THE U.S. PATENT AND TRADEMARK OFFICE

January 15, 2009

Applicants: Atsushi YABE et al  
For: ELECTROLESS COPPER PLATING SOLUTION  
Serial No.: 10/576 231 Group: 1792  
Confirmation No.: 7188  
Filed: April 14, 2006 Examiner: Bareford  
International Application No.: PCT/JP2004/011327  
International Filing Date: July 30, 2004  
Atty. Docket No.: 4700.P0327US  
Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**REQUEST FOR RECONSIDERATION**

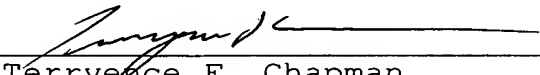
Sir:

In response to the Office Action dated October 20, 2008,  
Applicants respectfully request reconsideration.

(Please see the following pages.)

-----  
**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being  
deposited with the United States Postal Service as first class  
mail in an envelope addressed to: Assistant Commissioner for  
Patents, Washington, DC 20231 on January 15, 2009.

  
Terryence F. Chapman